Assembly Bill of Materials

Texas Instruments



Project Name:	LM5017 Capacitor Drop
Project File:	PMP9310.PrjPCB
Base ID:	PMP9304
Schematic Rev:	A
Assembly Variant:	001
Build Quantity:	1
Generated:	2/3/2014 9:57:13 AM

Item	Designator	Description	RoHS	Manufacturer	PartNumber	Quantity	Required	Supplier 1	Supplier Part Number 1	Supplier 2	Supplier Part Number 2	Alternate Manufacturer	Alternate PartNumber
1	C1, C5	CAP, CERM, 10uF, 100V, +/-20%, X7S, 2220	Υ	TDK	C5750X7S2A106M	1	1	Digi-Key	445-5212-1-ND			-	-
2	C5	CAP, CERM, 22uF, 100V, +/-20%, X7S, 2220	Y	TDK	CKG57NX7S2A226M500JH	1	1	Digi-Key					
3	C4	CAP, CERM, 2700pF, 25V, +/-10%, X7R, 0603	Υ	MuRata	GRM188R71E272KA01D	1	1	Digi-Key	GRM188R71E272KA01D-ND	Mouser	81-GRM188R71E272KA1D		
4		CAP, CERM, 4.7uF, 6.3V, +/-10%, X5R, 0603	Y	Kemet	C0603C475K9PACTU	1	1	Digi-Key	399-3482-1-ND	Mouser	80-C0603C475K9P		
5		CAP, Film, 0.39uF, 630V, +/-10%, TH	Y	EPCOS Inc	B32923C3394K	1	1	Farnell					
6		CAP, AL, 220uF, 100V, +/-20%, 0.16 ohm, SMD	Y	Nippon Chemi-Con	EMVH101GDA221MMN0S	1	1	Digi-Key	565-2345-1-ND	Mouser	661-MVH100M221M		
7		CAP, CERM, 1uF, 16V, +/-10%, X7R, 0603	Y	MuRata	GRM188R71C105KA12D	2	2	Digi-Key	490-3900-1-ND	Mouser	81-GRM188R71C105KA12		
8		CAP, CERM, 1uF, 25V, +/-10%, X5R, 0603	Y	MuRata	GRM188R61E105KA12D	1	1	Digi-Key	490-3897-1-ND	Mouser	81-GRM188R61E105KA12		
9		CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	Y	AVX	06035C104KAT2A	1	1	Digi-Key	478-5052-1-ND	Mouser	581-06035C104KAT2A		
10		Diode, P-N, 1000V, 1A, SOD-123		Comchip Technology	CGRM4007-G	1	1	Digi-Key	641-1330-1-ND	Mouser	750-CGRM4007-G		
11	D2	Diode, Zener, 7.5V, 500mW, SOD-123	Y	ON Semiconductor	MMSZ4693T1G	1	1	Digi-Key					
		Diode, Zener, 62V, 500mW, SOD-123		ON Semiconductor	MMSZ5265BT1G	1	1	Digi-Key					
13	D3	Diode, Zener, 10V, 550mW,	Y	ON Semiconductor	1SMB5925BT3G	1	1	Mouser	863-1SMB5925BT3G	Farnell	1431168		
14	D5	Diode, Schottky, 60V, 1A, SOD-123F	Y	NXP Semiconductor	PMEG6010CEH,115	1	1	Digi-Key	568-4104-1-ND	Farnell	1510694		
15	D6	Diode, Zener, 62V, 550mW.	Y	ON Semiconductor	1SMB5944BT3G	1	1	Mouser	863-1SMB5944BT3G	Newark	71J9222		
16	EN. SW	Test Point, Miniature, White, TH	Y	Keystone	5002	2	2	Digi-Key	5002K-ND	Newark	82H9632		
17	FID1, FID2, FID3	Fiducial mark. There is nothing to buy or mount.		N/A	N/A	3	3						
18	H1, H2, H3, H4	Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Y	B&F Fastener Supply	NY PMS 440 0025 PH	4	4	Digi-Key	H542-ND			-	-
19	H5, H6, H7, H8	Standoff, Hex. 0.5"I, #4-40 Nylon	V	Vt	1902C			Digi-Kev	1902CK-ND				
20		Inductor, Shielded Drum Core, Ferrite, 270uH, 1,2A, 0,42	Y	Keystone Coilcraft	MSS1278-274KLB	4	4	Digi-Key	1902CK-ND			-	-
20		ohm, SMD	1	Colician		'	'						
21		Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10.000 per roll	Υ	Brady	THT-14-423-10	1	1	Farnell	2065596	Newark	97C5133	-	-
22		RES, 200 ohm, 1%, 0.25W, 1206	~	Yageo America	RC1206FR-07200RI	3	3	Digi-Kev	311-100FRCT-ND	Mouser	603-RC1206FR-07100RI		
23		RES, 30.9k ohm, 1%, 0.1W, 0603	·	Yageo America	RC0603FR-0730K9I	1	1	Digi-Key Digi-Key	311-30.9KHRCT-ND	Mouser	603-RC0603FR-0730K9I		
24		RES, 200k ohm, 1%, 0.1W, 0603	,	Vishav-Dale	CRCW0603200KFKEA	1	1	Digi-Key Digi-Key	541-200KHCT-ND	Mouser	71-CRCW0603-200K-E3		
25		RES, 1,00 ohm, 1%, 0,1W, 0603	·	Vishay-Dale Vishay-Dale	CRCW06031R00FKEA	2	2	Mouser	71-CRCW06031R00FKEA	Farnell	1616871		
26		RES, 50.5k ohm, 0.1%, 0.1W, 0603	, ,	Yageo America	RT0603BRD0750K5L	4	4	iviousei	7 I-CKCW0003 IKOOFKEA	i airicii	1010071		
27		RES, 6.04k ohm, 1%, 0.1W, 0603	, ·	Vishav-Dale	CRCW06036K04FKEA	1	1	Digi-Kev	541-6.04KHCT-ND	Mouser	71-CRCW0603-6.04K-E3		
28		RES, 328k ohm, 0.5%, 0.1W, 0603	÷	Yageo America	RT0603DRE07328KL	1	1	Digiritoy	0-1-0.04KH01-ND	IVIOUSEI	7 1-GROW0003-0.04R-E3		
28		RES, 10.0k ohm, 1%, 0.1W, 0603	, v	Vishav-Dale	CRCW060310K0FKEA	4	,	Digi-Kev	541-10.0KHCT-ND	Mouser	71-CRCW0603-10K-E3		
30		Test Point, Multipurpose, Black, TH	V	Visnay-Dale Kevstone	5011	1	2	Digi-Key Digi-Key	541-10.0KHC1-ND 5011K-ND	wouser	/ I-GRUWU0U3-1UN-E3		
30		Dual 5A Compound Gate Driver with Negative Output	, ,	National Semiconductor	LM5110-1MX	2	2	Digi-Ney	DUT IN-IND				
31	UT		1	ivational Serniconductor	LIVISTTU-TIVIA	' '	'		1		1		l
00	VII. VII. VIO. VIO.	Voltage Capability, 8-pin Narrow SOIC	V	Vt	4500.0			Diel Ken	4500 OK ND				
32		Terminal, Turret, TH, Double	Y	Keystone	1502-2	4		Digi-Key	1502-2K-ND				
33	VIN	Test Point, Miniature, Red, TH	Y	Keystone	5000	1	1	Digi-Key	5000K-ND				
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PMP9310 REV 2 (001) EVM BOM Page 1

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